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Diodes Incorporated DMN3025LSS-13

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DMN3025LSS

N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
30V	20mΩ @ V _{GS} = 10V	7.2A
	31mΩ @ V _{GS} = 4.5V	5.8A

Description

This MOSFET has been designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Backlighting
- **Power Management Functions**
- **DC-DC Converters**

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 standards for High Reliability

Mechanical Data

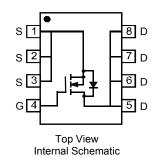
Case: SO-8

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- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.008 grams (approximate)



Top View



Ordering Information (Note 4)

Part Number	Case	Packaging
DMN3025LSS-13	SO-8	2500/Tape & Reel

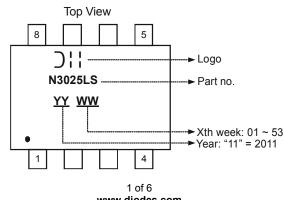
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. Notes:

2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds

4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



DMN3025LSS Document number: DS35746 Rev. 3 - 2 www.diodes.com

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DMN3025LSS

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units	
Drain-Source Voltage			V _{DSS}	30	V	
Gate-Source Voltage			V _{GSS}	±20	V	
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	T _A = +25°C T _A = +70°C	۱ _D	7.2 5.7	А	
	t<10s	T _A = +25°C T _A = +70°C	ID	9.6 7.7	A	
Maximum Continuous Body Diode Forward Current (Note 6)			I _S	3	A	
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	40	A	
Avalanche Current (L = 0.1mH)			I _{AS}	14.5	А	
Repetitive Avalanche Energy (L = 0.1mH)			E _{AS}	10.5	mJ	

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Total Power Dissipation (Note 5)	T _A = +25°C	Р	1.4	W	
Total Power Dissipation (Note 5)	T _A = +70°C	PD	0.9		
Thermal Desistance, Junction to Ambient (Note E)	Steady State	Devi	87	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	R _{θJA}	44		
Total Power Dissipation (Note 6)	T _A = +25°C	Π.	1.7	W	
Total Power Dissipation (Note 6)	T _A = +70°C	PD	1.1	vv	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Davi	73	°C/W	
Thermal Resistance, Junction to Amblent (Note 6)	t<10s	R _{0JA}	37	C/W	
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

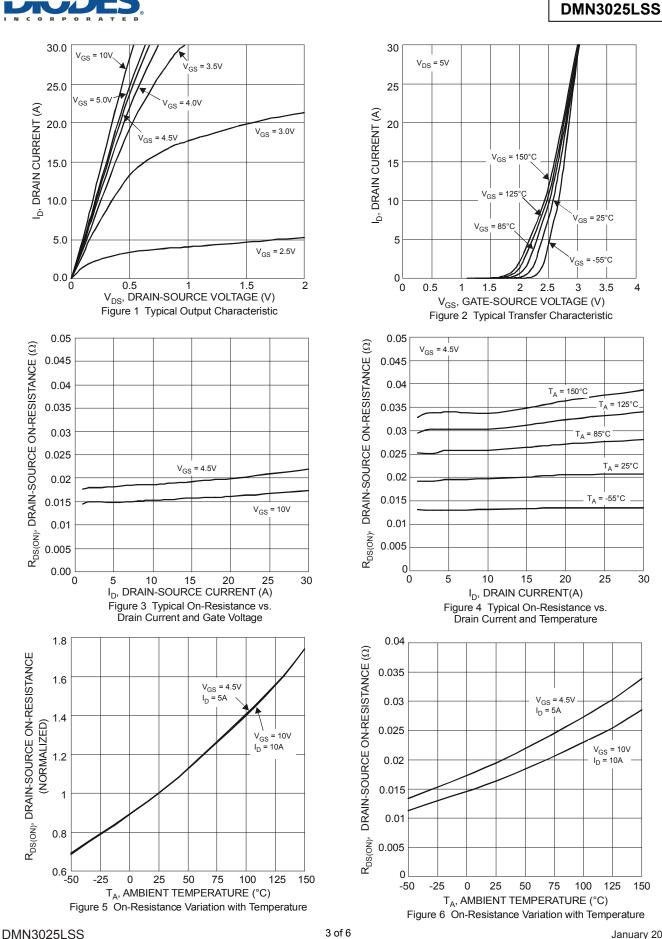
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

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Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	—	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	—		1	μA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	—	_	±1	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)	-						
Gate Threshold Voltage	V _{GS(th)}	0.8	-	2.0	V	V_{DS} = V_{GS} , I_D = 250 μ A	
Static Drain-Source On-Resistance			14	20	mΩ	V _{GS} = 10V, I _D = 10A	
	R _{DS (ON)}	_	23	31		V _{GS} = 4.5V, I _D = 7.5A	
Forward Transfer Admittance	Y _{fs}	_	11	-	S	V _{DS} = 5V, I _D = 10A	
Diode Forward Voltage	V _{SD}	_	0.70	1.0	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}		641	—		V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss	—	66	—	pF		
Reverse Transfer Capacitance	Crss	_	50	-		1 - 1:00012	
Gate resistance	Rg	_	2.2	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	6	—			
Total Gate Charge (V _{GS} = 10V)	Qg	—	13.2	-		V _{DS} = 15V, I _D = 10A	
Gate-Source Charge	Qgs	_	1.7	—	nC		
Gate-Drain Charge	Q _{gd}	_	2.2	—			
Turn-On Delay Time	t _{D(on)}	—	3.3	—		V _{DD} = 15V, V _{GS} = 10V, R _G = 6Ω, I _D = 1A	
Turn-On Rise Time	tr	—	4.4	_			
Turn-Off Delay Time	t _{D(off)}	—	22.3	—	ns		
Turn-Off Fall Time	t _f	—	5.3	—			

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing.

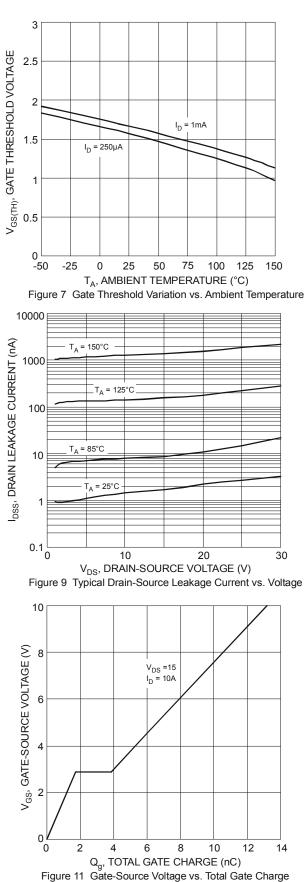


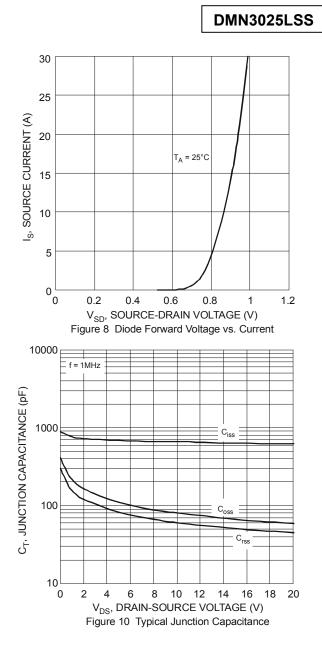


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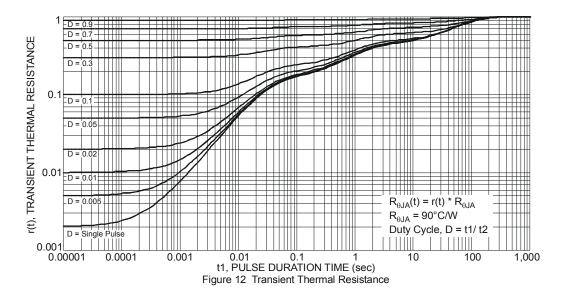


NEW PRODUCT

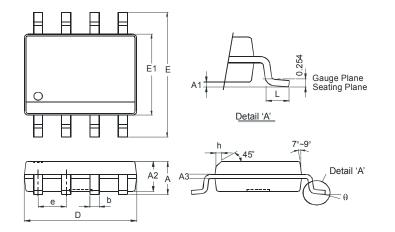




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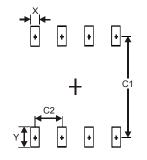


Package Outline Dimensions



SO-8				
Dim	Min	Max		
Α	-	1.75		
A1	0.10	0.20		
A2	1.30	1.50		
A3	0.15	0.25		
b	0.3	0.5		
D	4.85	4.95		
Е	5.90	6.10		
E1	3.85	3.95		
е	1.27	Тур		
h	-	0.35		
L	0.62	0.82		
θ	0°	8°		
All Dimensions in mm				

Suggested Pad Layout



Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1.27

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